ATTORNEY DOCKET NUMBER: 4459-140

Sir:

Transmitted herewith for filing is the Utility patent application of:

INVENTOR (S):	Su TAO; Shih Chang LEE
FOR:	SEMICONDUCTOR CHIP PACKAGE AND METHOD FOR MANUFACTURING THE SAME

## Enclosed are:

- ☐ Note that Not
- 10 sheets of formal drawings
- Declaration & Power of Attorney
- Claim of Priority under 35 U.S.C. § 119
- An assignment with PTO Form 1595
- Return Receipt Postcard

The filing fee is calculated as shown below:

7.33	NO.	FILED	NO. EXTRA	RATE	AMOUNT	
Total Claims	27	MINUS 20	7	x \$18 =	\$ 126.00	
Independent Claims	4	MINUS 3	1	x \$ 86 =	\$ 86.00	
If multiple dependent claims are presented, add \$ 290.00						
Basic Fee						
Applicant claims small entity status. See 37 CFR 1.27. The fees indicated above are reduced by ½.						
Total of above calculations						
TOTAL FEE						

A credit card authorization form to cover the filing fees is enclosed.

The Commissioner is hereby authorized to charge any additional fees associated with this communication, including patent application filing fees and processing fees under 37 C.F.R. § 1.16 and 1.77, or credit any overpayment to **Deposit Account Number 07-1337**.

Respectfully submitted,

LOWE HAUPTMAN GILMAN & BERNER, LLP (22429)

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ВЈН:ЕТР

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